# **Binary Up/Down Counter**

The MC14516B synchronous up/down binary counter is constructed with MOS P-channel and N-channel enhancement mode devices in a monolithic structure.

This counter can be preset by applying the desired value, in binary, to the Preset inputs (P0, P1, P2, P3) and then bringing the Preset Enable (PE) high. The direction of counting is controlled by applying a high (for up counting) or a low (for down counting) to the UP/DOWN input. The state of the counter changes on the positive transition of the clock input.

Cascading can be accomplished by connecting the  $\overline{\text{Carry Out}}$  to the  $\overline{\text{Carry In}}$  of the next stage while clocking each counter in parallel. The outputs (Q0, Q1, Q2, Q3) can be reset to a low state by applying a high to the reset (R) pin.

This CMOS counter finds primary use in up/down and difference counting. Other applications include: (1) Frequency synthesizer applications where low power dissipation and/or high noise immunity is desired, (2) Analog-to-Digital and Digital-to-Analog conversions, and (3) Magnitude and sign generation.

#### **Features**

- Diode Protection on All Inputs
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Internally Synchronous for High Speed
- Logic Edge-Clocked Design Count Occurs on Positive Going Edge of Clock
- Single Pin Reset
- Asynchronous Preset Enable Operation
- Capable of Driving Two Low-Power TTL Loads or One Low-Power Schottky Load Over the Rated Temperature Range
- Pb-Free Packages are Available\*

# **MAXIMUM RATINGS** (Voltages Referenced to V<sub>SS</sub>)

| Parameter   | Symbol                             | Value                            | Unit |
|---|------------------------------------|----------------------------------|------|
| DC Supply Voltage Range                           | $V_{DD}$                           | -0.5 to +18.0                    | V    |
| Input or Output Voltage Range (DC or Transient)   | V <sub>in</sub> , V <sub>out</sub> | -0.5 to V <sub>DD</sub><br>+ 0.5 | V    |
| Input or Output Current (DC or Transient) per Pin | I <sub>in</sub> , I <sub>out</sub> | ±10                              | mA   |
| Power Dissipation, per Package (Note 1)           | P <sub>D</sub>                     | 500                              | mW   |
| Ambient Temperature Range                         | T <sub>A</sub>                     | -55 to +125                      | °C   |
| Storage Temperature Range                         | T <sub>stg</sub>                   | -65 to +150                      | °C   |
| Lead Temperature (8–Second Soldering)             | TL                                 | 260                              | °C   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

 Temperature Derating: Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOI DERRM/D.



# ON Semiconductor®

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MARKING DIAGRAMS



PDIP-16 P SUFFIX CASE 648 

SOIC-16 D SUFFIX CASE 751B 

SOEIAJ-16 F SUFFIX CASE 966 A = Assembly Location

WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week
G = Pb-Free Package

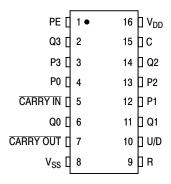
#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

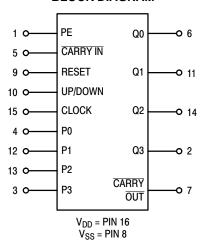
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V<sub>SS</sub> or V<sub>DD</sub>). Unused outputs must be left open.

# **PIN ASSIGNMENT**



#### **BLOCK DIAGRAM**



#### **TRUTH TABLE**

| Carry In | Up/Down | Preset Enable | Reset | Clock | Action     |
|----------|---------|---------------|-------|-------|------------|
| 1        | X       | 0             | 0     | Х     | No Count   |
| 0        | 1       | 0             | 0     |       | Count Up   |
| 0        | 0       | 0             | 0     |       | Count Down |
| X        | Х       | 1             | 0     | Х     | Preset     |
| Х        | Х       | Х             | 1     | Х     | Reset      |

X = Don't Care

NOTE: When counting up, the Carry Out signal is normally high and is low only when Q0 through Q3 are high and Carry In is low. When counting down, Carry Out is low only when Q0 through Q3 and Carry In are low.

#### ORDERING INFORMATION

| Device       | Package                | Shipping <sup>†</sup> |
|--------------|------------------------|-----------------------|
| MC14516BCP   | PDIP-16                |                       |
| MC14516BCPG  | PDIP-16<br>(Pb-Free)   | 25 Units / Rail       |
| MC14516BD    | SOIC-16                |                       |
| MC14516BDG   | SOIC-16<br>(Pb-Free)   | 48 Units / Rail       |
| MC14516BDR2  | SOIC-16                |                       |
| MC14516BDR2G | SOIC-16<br>(Pb-Free)   | 2500 / Tape & Reel    |
| MC14516BF    | SOEIAJ-16              |                       |
| MC14516BFG   | SOEIAJ-16<br>(Pb-Free) | 50 Units / Rail       |
| MC14516BFEL  | SOEIAJ-16              |                       |
| MC14516BFELG | SOEIAJ-16<br>(Pb-Free) | 2000 / Tape & Reel    |
|              |                        |                       |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **ELECTRICAL CHARACTERISTICS** (Voltages Referenced to V<sub>SS</sub>)

|  |                 |                        | - 5                               | 5°C                  |                                   | 25°C                                      |                      | 12                                | 5°C                  |      |
|--|-----------------|------------------------|-----------------------------------|----------------------|-----------------------------------|---|----------------------|-----------------------------------|----------------------|------|
| Characteristic   | Symbol          | V <sub>DD</sub><br>Vdc | Min                               | Max                  | Min                               | Typ<br>(Note 2)                           | Max                  | Min                               | Max                  | Unit |
| Output Voltage "0" Level $V_{in} = V_{DD}$ or 0  | V <sub>OL</sub> | 5.0<br>10<br>15        | -<br>-<br>-                       | 0.05<br>0.05<br>0.05 | -<br>-<br>-                       | 0<br>0<br>0                               | 0.05<br>0.05<br>0.05 | -<br>-<br>-                       | 0.05<br>0.05<br>0.05 | Vdc  |
| $V_{in} = 0$ or $V_{DD}$ "1" Level   | V <sub>OH</sub> | 5.0<br>10<br>15        | 4.95<br>9.95<br>14.95             | -<br>-<br>-          | 4.95<br>9.95<br>14.95             | 5.0<br>10<br>15                           | -<br>-<br>-          | 4.95<br>9.95<br>14.95             | -<br>-<br>-          | Vdc  |
| Input Voltage "0" Level $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$ | V <sub>IL</sub> | 5.0<br>10<br>15        | -<br>-<br>-                       | 1.5<br>3.0<br>4.0    | -<br>-<br>-                       | 2.25<br>4.50<br>6.75                      | 1.5<br>3.0<br>4.0    | -<br>-<br>-                       | 1.5<br>3.0<br>4.0    | Vdc  |
| "1" Level $(V_O = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_O = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_O = 1.5 \text{ or } 13.5 \text{ Vdc})$               | V <sub>IH</sub> | 5.0<br>10<br>15        | 3.5<br>7.0<br>11                  | -<br>-<br>-          | 3.5<br>7.0<br>11                  | 2.75<br>5.50<br>8.25                      | -<br>-<br>-          | 3.5<br>7.0<br>11                  | -<br>-<br>-          | Vdc  |
| Output Drive Current   | ІОН             | 5.0<br>5.0<br>10<br>15 | - 3.0<br>- 0.64<br>- 1.6<br>- 4.2 | -<br>-<br>-          | - 2.4<br>- 0.51<br>- 1.3<br>- 3.4 | - 4.2<br>- 0.88<br>- 2.25<br>- 8.8        | -<br>-<br>-          | - 1.7<br>- 0.36<br>- 0.9<br>- 2.4 | -<br>-<br>-<br>-     | mAdc |
| $(V_{OL} = 0.4 \text{ Vdc})$ Sink $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$  | I <sub>OL</sub> | 5.0<br>10<br>15        | 0.64<br>1.6<br>4.2                | -<br>-<br>-          | 0.51<br>1.3<br>3.4                | 0.88<br>2.25<br>8.8                       | -<br>-<br>-          | 0.36<br>0.9<br>2.4                | -<br>-<br>-          | mAdc |
| Input Current  | I <sub>in</sub> | 15                     | -                                 | ± 0.1                | -                                 | ±0.00001                                  | ± 0.1                | -                                 | ± 1.0                | μAdc |
| Input Capacitance (V <sub>in</sub> = 0)  | C <sub>in</sub> | _                      | _                                 | -                    | _                                 | 5.0                                       | 7.5                  | _                                 | _                    | pF   |
| Quiescent Current (Per Package)  | I <sub>DD</sub> | 5.0<br>10<br>15        | -<br>-<br>-                       | 5.0<br>10<br>20      | -<br>-<br>-                       | 0.005<br>0.010<br>0.015                   | 5.0<br>10<br>20      | -<br>-<br>-                       | 150<br>300<br>600    | μAdc |
| Total Supply Current (Note 3, 4) (Dynamic plus Quiescent, Per Package) (C <sub>L</sub> = 50 pF on all outputs, all buffers switching)                  | IT              | 5.0<br>10<br>15        | -                                 |                      | $I_{T} = (1$                      | .58 μΑ/kHz)<br>.20 μΑ/kHz)<br>.70 μΑ/kHz) | f + I <sub>DD</sub>  |                                   |                      | μAdc |

Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
 The formulas given are for the typical characteristics only at 25°C.
 To calculate total supply current at loads other than 50 pF: I<sub>T</sub>(C<sub>L</sub>) = I<sub>T</sub>(50 pF) + (C<sub>L</sub> – 50) Vfk where: I<sub>T</sub> is in μA (per package), C<sub>L</sub> in pF, V = (V<sub>DD</sub> – V<sub>SS</sub>) in volts, f in kHz is input frequency, and k = 0.001.

# **SWITCHING CHARACTERISTICS** (Note 5) ( $C_L = 50 \text{ pF}, T_A = 25^{\circ}C$ )

|  |  |                 |                      | All Types             |                    | _    |
|--|--|-----------------|----------------------|-----------------------|--------------------|------|
| Characteristic   | Symbol                                 | $V_{DD}$        | Min                  | Typ (Note 6)          | Max                | Unit |
| Output Rise and Fall Time $t_{TLH}$ , $t_{THL} = (1.5 \text{ ns/pF}) \text{ C}_L + 25 \text{ ns}$ $t_{TLH}$ , $t_{THL} = (0.75 \text{ ns/pF}) \text{ C}_L + 12.5 \text{ ns}$ $t_{TLH}$ , $t_{THL} = (0.55 \text{ ns/pF}) \text{ C}_L + 9.5 \text{ ns}$   | t <sub>TLH</sub> ,<br>t <sub>THL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | 100<br>50<br>40       | 200<br>100<br>80   | ns   |
| Propagation Delay Time  Clock to Q $t_{PLH}$ , $t_{PHL} = (1.7 \text{ ns/pF}) C_L + 230 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 97 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 75 \text{ ns}$   | t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | 315<br>130<br>100     | 630<br>260<br>200  | ns   |
| Clock to $\overline{\text{Carry Out}}$<br>$t_{\text{PLH}}$ , $t_{\text{PHL}} = (1.7 \text{ ns/pF}) C_{\text{L}} + 230 \text{ ns}$<br>$t_{\text{PLH}}$ , $t_{\text{PHL}} = (0.66 \text{ ns/pF}) C_{\text{L}} + 97 \text{ ns}$<br>$t_{\text{PLH}}$ , $t_{\text{PHL}} = (0.5 \text{ ns/pF}) C_{\text{L}} + 75 \text{ ns}$ | t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | 315<br>130<br>100     | 630<br>260<br>200  | ns   |
| Carry In to Carry Out $t_{PLH}$ , $t_{PHL} = (1.7 \text{ ns/pF}) C_L + 230 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.66 \text{ ns/pF}) C_L + 97 \text{ ns}$ $t_{PLH}$ , $t_{PHL} = (0.5 \text{ ns/pF}) C_L + 75 \text{ ns}$  | t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | 180<br>80<br>60       | 360<br>160<br>120  | ns   |
| Preset or Reset to Q t <sub>PLH</sub> , t <sub>PHL</sub> = $(1.7 \text{ ns/pF})$ C <sub>L</sub> + 230 ns t <sub>PLH</sub> , t <sub>PHL</sub> = $(0.66 \text{ ns/pF})$ C <sub>L</sub> + 97 ns t <sub>PLH</sub> , t <sub>PHL</sub> = $(0.5 \text{ ns/pF})$ C <sub>L</sub> + 75 ns  | t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | 315<br>130<br>100     | 630<br>360<br>200  | ns   |
| Preset or Reset to $\overline{\text{Carry Out}}$ tplh, tphL = (1.7 ns/pF) C <sub>L</sub> + 465 ns tplh, tphL = (0.66 ns/pF) C <sub>L</sub> + 192 ns tplh, tphL = (0.5 ns/pF) C <sub>L</sub> + 125 ns   | t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | 550<br>225<br>150     | 1100<br>450<br>300 | ns   |
| Reset Pulse Width  | t <sub>w</sub>                         | 5.0<br>10<br>15 | 380<br>200<br>160    | 190<br>100<br>80      | -<br>-<br>-        | ns   |
| Clock Pulse Width  |  | 5.0<br>10<br>15 | 350<br>170<br>- 140  | 200<br>100<br>— 75    | -<br>-<br>-        | ns   |
| Clock Pulse Frequency  | f <sub>cl</sub>                        | 5.0<br>10<br>15 | -<br>-<br>-          | 3.0<br>6.0<br>8.0     | 1.5<br>3.0<br>4.0  | MHz  |
| Preset or Reset Removal Time The Preset or Reset signal must be low prior to a positive–going transition of the clock.   | t <sub>rem</sub>                       | 5.0<br>10<br>15 | 650<br>230<br>180    | 325<br>115<br>90      | -                  | ns   |
| Clock Rise and Fall Time   | t <sub>TLH</sub> ,<br>t <sub>THL</sub> | 5.0<br>10<br>15 | -<br>-<br>-          | -<br>-<br>-           | 15<br>5<br>4       | μS   |
| Setup Time<br>Carry In to Clock  | t <sub>su</sub>                        | 5.0<br>10<br>15 | 260<br>120<br>100    | 130<br>60<br>50       | -<br>-<br>-        | ns   |
| Hold Time<br>Clock to Carry In   | t <sub>h</sub>                         | 5.0<br>10<br>15 | 0<br>20<br>20        | - 60<br>- 20<br>0     | -<br>-<br>-        | ns   |
| Setup Time<br>Up/Down to Clock   | t <sub>su</sub>                        | 5.0<br>10<br>15 | 500<br>200<br>150    | 250<br>100<br>75      | _<br>_<br>_        | ns   |
| Hold Time<br>Clock to Up/Down  | t <sub>h</sub>                         | 5.0<br>10<br>15 | - 70<br>- 10<br>0    | - 160<br>- 60<br>- 40 | _<br>_<br>_        | ns   |
| Setup Time<br>Pn to PE   | t <sub>su</sub>                        | 5.0<br>10<br>15 | - 40<br>- 30<br>- 25 | - 120<br>- 70<br>- 50 | _<br>_<br>_        | ns   |
| Hold Time<br>PE to Pn  | t <sub>h</sub>                         | 5.0<br>10<br>15 | 480<br>420<br>420    | 240<br>210<br>210     | _<br>_<br>_        | ns   |
| Preset Enable Pulse Width  | t <sub>WH</sub>                        | 5.0<br>10<br>15 | 200<br>100<br>80     | 100<br>50<br>40       | -<br>-<br>-        | ns   |

<sup>5.</sup> The formulas given are for the typical characteristics only at 25°C.6. Data labelled "Typ" is not to be used for design purposes but is intended as an Indication of the IC's potential performance.

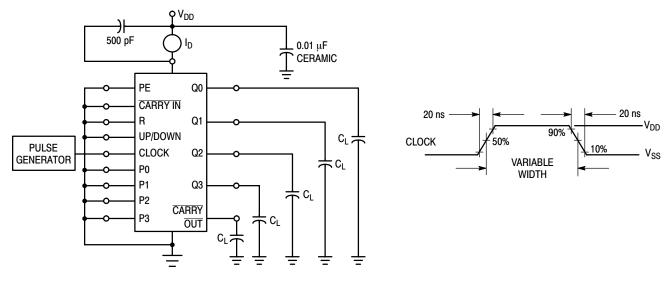
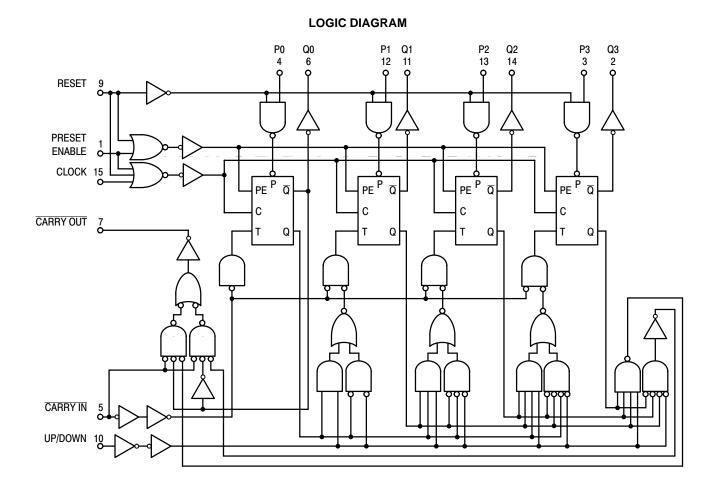
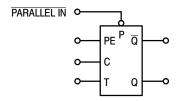


Figure 1. Power Dissipation Test Circuit and Waveform



#### **TOGGLE FLIP-FLOP**



#### FLIP-FLOP FUNCTIONAL TRUTH TABLE

| Preset<br>Enable | Clock | т | Q <sub>n+1</sub> |
|------------------|-------|---|------------------|
| 1                | Х     | Х | Parallel In      |
| 0                | _     | 0 | Q <sub>n</sub>   |
| 0                | _     | 1 | $\overline{Q}_n$ |
| 0                | ~     | Х | Q <sub>n</sub>   |

X = Don't Care

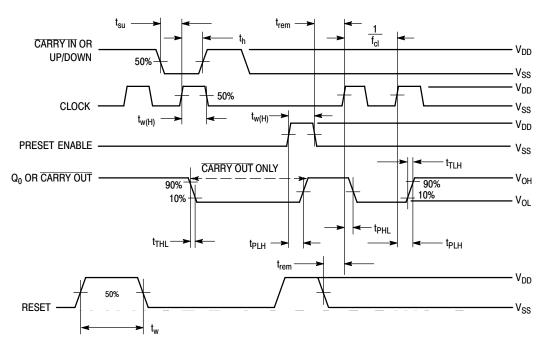


Figure 2. Switching Time Waveforms

#### PIN DESCRIPTIONS

# **INPUTS**

P0, P1, P2, P3, Preset Inputs (Pins 4, 12, 13, 3) — Data on these inputs is loaded into the counter when PE is taken high.

Carry In, (Pin 5) — This active—low input is used when Cascading stages. Carry In is usually connected to Carry Out of the previous stage. While high, Clock is inhibited.

**Clock, (Pin 15)** — Binary data is incremented or decremented, depending on the direction of count, on the positive transition of this input.

#### **OUTPUTS**

Q0, Q1, Q2, Q3, Binary outputs (Pins 6, 11, 14, 2) — Binary data is present on these outputs with Q0 corresponding to the least significant bit.

Carry Out, (Pin 7) — Used when cascading stages, Carry Out is usually connected to Carry In of the next stage. This synchronous output is active low and may also be used to indicate terminal count.

# **CONTROLS**

**PE, Preset Enable, (Pin 1)** — Asynchronously loads data on the Preset Inputs. This pin is active high and inhibits the clock when high.

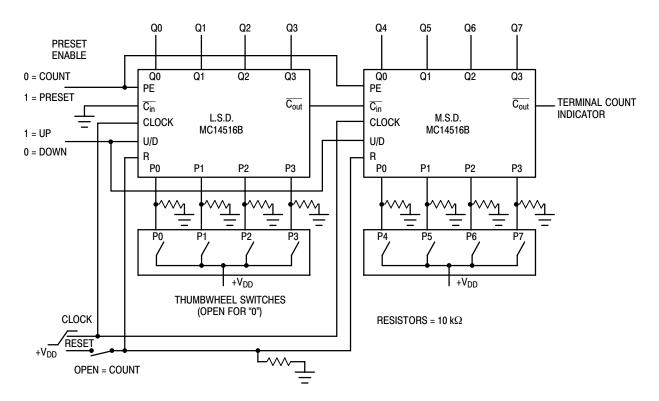
**R, Reset, (Pin 9)** — Asynchronously resets the Q outputs to a low state. This pin is active high and inhibits the clock when high.

**Up/Down**, (**Pin 10**) — Controls the direction of count, high for up count, low for down count.

#### **SUPPLY PINS**

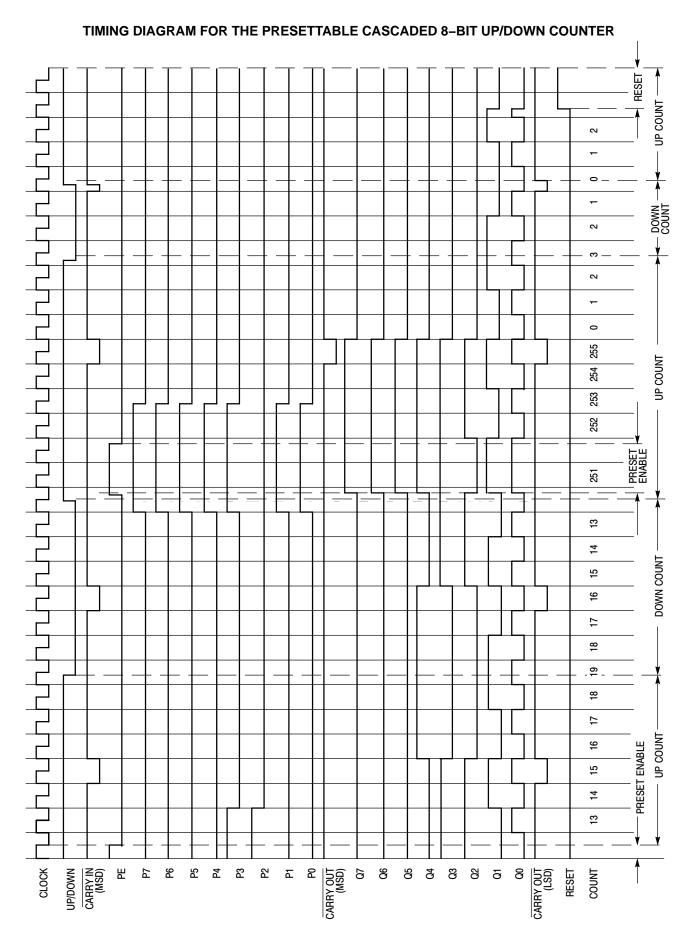
V<sub>SS</sub>, Negative Supply Voltage, (Pin 8) — This pin is usually connected to ground.

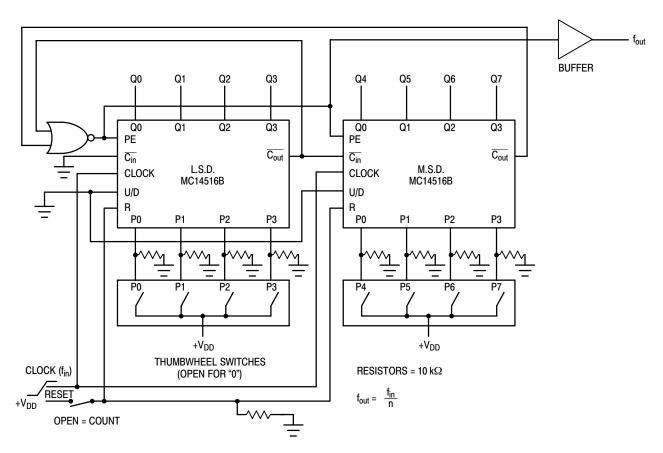
**V<sub>DD</sub>**, **Positive Supply Voltage**, (**Pin 16**) — This pin is connected to a positive supply voltage ranging from 3.0 V to 18 V.



NOTE: The Least Significant Digit (L.S.D.) counts from a preset value once Preset Enable (PE) goes low. The Most Significant Digit (M.S.D.) is disabled while  $\overline{C_{in}}$  is high. When the count of the L.S.D. reaches 0 (count down mode) or reaches 15 (count up mode),  $\overline{C_{out}}$  goes low for one complete clock cycle, thus allowing the next counter to decrement/increment one count. (See Timing Diagram) The L.S.D. now counts through another cycle (15 clock pulses) and the above cycle is repeated.

Figure 3. Presettable Cascaded 8-Bit Up/Down Counter



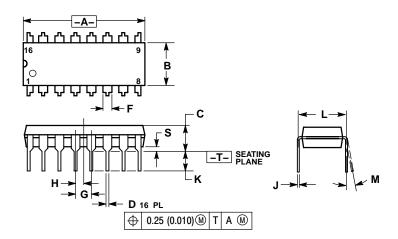


NOTE: The programmable frequency divider can be set by applying the desired divide ratio, in binary, to the preset inputs. For example, the maximum divide ratio of 255 may be obtained by applying a 1111 1111 to the preset inputs P0 to P7. For this divide operation, both counters should be configured in the count down mode. The divide ratio of zero is an undefined state and should be avoided.

Figure 4. Programmable Cascaded Frequency Divider

#### PACKAGE DIMENSIONS

# PDIP-16 CASE 648-08 **ISSUE T**

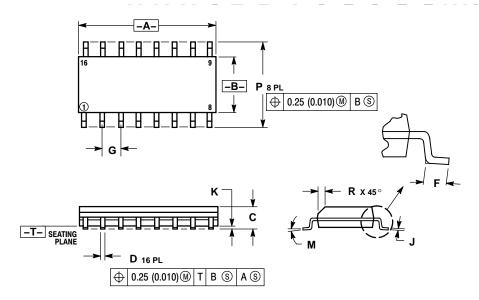


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD ELACH
- MOLD FLASH.

  5. ROUNDED CORNERS OPTIONAL.

|     | INC   | HES   | MILLIN | IETERS |
|-----|-------|-------|--------|--------|
| DIM | MIN   | MAX   | MIN    | MAX    |
| Α   | 0.740 | 0.770 | 18.80  | 19.55  |
| В   | 0.250 | 0.270 | 6.35   | 6.85   |
| С   | 0.145 | 0.175 | 3.69   | 4.44   |
| D   | 0.015 | 0.021 | 0.39   | 0.53   |
| F   | 0.040 | 0.70  | 1.02   | 1.77   |
| G   | 0.100 | BSC   | 2.54   | BSC    |
| Н   | 0.050 | BSC   | 1.27   | BSC    |
| J   | 0.008 | 0.015 | 0.21   | 0.38   |
| K   | 0.110 | 0.130 | 2.80   | 3.30   |
| L   | 0.295 | 0.305 | 7.50   | 7.74   |
| M   | 0°    | 10 °  | 0°     | 10 °   |
| S   | 0.020 | 0.040 | 0.51   | 1.01   |

# SOIC-16 CASE 751B-05 **ISSUE J**



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

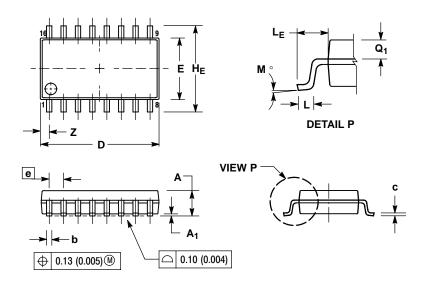
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PER SIDE.

  5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL
  IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

|     | MILLIN   | IETERS | INC   | HES   |
|-----|----------|--------|-------|-------|
| DIM | MIN      | MAX    | MIN   | MAX   |
| Α   | 9.80     | 10.00  | 0.386 | 0.393 |
| В   | 3.80     | 4.00   | 0.150 | 0.157 |
| C   | 1.35     | 1.75   | 0.054 | 0.068 |
| D   | 0.35     | 0.49   | 0.014 | 0.019 |
| F   | 0.40     | 1.25   | 0.016 | 0.049 |
| G   | 1.27 BSC |        | 0.050 | BSC   |
| J   | 0.19     | 0.25   | 0.008 | 0.009 |
| K   | 0.10     | 0.25   | 0.004 | 0.009 |
| M   | 0°       | 7°     | 0°    | 7°    |
| P   | 5.80     | 6.20   | 0.229 | 0.244 |
| R   | 0.25     | 0.50   | 0.010 | 0.019 |

#### PACKAGE DIMENSIONS

### SOEIAJ-16 CASE 966-01 ISSUE A



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS D AND E DO NOT INCLUDE
  MOLD FLASH OR PROTRUSIONS AND ARE
  MEASURED AT THE PARTING LINE. MOLD FLASH
  OR PROTRUSIONS SHALL NOT EXCEED 0.15
  (0.006) PER SIDE.

  TERMINAL NUMBERS ARE SHOWN FOR
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
   THE LEAD WIDTH DIMENSION (b) DOES NOT
- 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

|                | MILLIN | IETERS   | INC   | HES   |
|----------------|--------|----------|-------|-------|
| DIM            | MIN    | MAX      | MIN   | MAX   |
| Α              |        | 2.05     |       | 0.081 |
| A <sub>1</sub> | 0.05   | 0.20     | 0.002 | 0.008 |
| b              | 0.35   | 0.50     | 0.014 | 0.020 |
| С              | 0.10   | 0.20     | 0.007 | 0.011 |
| D              | 9.90   | 10.50    | 0.390 | 0.413 |
| Ε              | 5.10   | 5.45     | 0.201 | 0.215 |
| е              | 1.27   | 1.27 BSC |       | BSC   |
| HE             | 7.40   | 8.20     | 0.291 | 0.323 |
| L              | 0.50   | 0.85     | 0.020 | 0.033 |
| LE             | 1.10   | 1.50     | 0.043 | 0.059 |
| M              | 0 °    | 10°      | 0°    | 10°   |
| Q <sub>1</sub> | 0.70   | 0.90     | 0.028 | 0.035 |
| Z              |        | 0.78     |       | 0.031 |

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